

EXPRESS MAIL LABEL NO. EV 394063305 US

PTO/SB/08A (04-03)

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Substitute for form 1449/PTO		Complete if Known	
<p>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</p> <p>(Use as many sheets as necessary)</p>			
Application Number	Not Known Yet	10/840 095	
Filing Date	05/06/2004		
First Named Inventor	Chao-Lung Chen		
Art Unit	Not Known Yet	2813	
Examiner Name	Not Known Yet		
Attorney Docket Number	N1085-00288		
Sheet 1	of 2		

FOREIGN PATENT DOCUMENTS					
Examiner Initials*	Cite No. ¹	Foreign Patent Document	Publication Date	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages Or Relevant Figures Appear
		Country Code ³ Number ⁴ Kind Code ⁵ (If Known)	MM-DD-YYYY		T ⁶

Examiner Signature	/Thanh Nguyen/ (04/28/2006)	Date Considered	04/28/2006
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		Attorney Docket Number	N1085-00288

NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
TN	H	SATO ET AL., "Newly Developed Electro-Chemical Polishing Process of Copper as Replacement of CMP Suitable for Damascene Copper Inlaid in Fragile Low-k Dielectrics", Electron Devices Meeting, 2001. IEDM Technical Digest. International, 2-5 Dec. 2001, Pages 4.4.1 - 4.4.4	
TN	I	GRANDIKOTA ET AL., "Influence of Plating Parameters on Reliability of Copper Metallization", Interconnect Technology Conference, 2002. Proceedings of the IEEE 2002 International, 3-5 June 2002, Pages 197 - 199	

Examiner Signature	/Thanh Nguyen/ (04/28/2006)	Date Considered	04/28/2006
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1 Applicant's unique citation designation number (optional). 2 Applicant is to place a check mark here if English language Translation is attached.

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